N-Channel Enhancement Mode Field Effect Transistor

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- These Devices are Pb-Free and are RoHS Compliant
- ESD HBM = 1000 V as per JESD22 A114 and ESD CDM = 1500 V as per JESD22 C101

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±20	V
	Ι _D	310 195 1.2	mA mA A
Operating Junction Temperature Range	TJ	-55 to +150	°C
Storage Temperature Range	T _{STG}	−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Total Device Dissipation Derating above T _A = 25°C	P _D	300 2.4	mW mW/°C
Thermal Resistance, Junction to Ambient*	$R_{ heta JA}$	410	°C/W

^{*}Device mounted on FR-4 PCB, 1" x 0.85" x 0.062". Minimum land pad size



ON Semiconductor®

www.onsemi.com

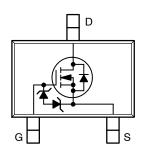


SC-70 3 LEAD CASE 419AB

MARKING DIAGRAM



7KW = Specific Device Marking



ORDERING INFORMATION[†]

Device	Package	Shipping [†]
2N7002KW	SC-70	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
FF CHARAC	TERISTICS					<u> </u>
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 10 μA	60	-	_	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125°C	-	-	1.0 0.5	μA mA
I _{GSS}	Gate-Body Leakage	V _{DS} = 0 V, V _{GS} = ±20 V	-	-	±10	μΑ
N CHARACT	ERISTICS (Note 1)					-
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.1	-	2.1	V
R _{DS(on)}	Static Drain-Source On-Resistance	$\begin{aligned} &V_{GS} = 10 \text{ V, } I_D = 500 \text{ mA} \\ &V_{GS} = 10 \text{ V, } I_D = 500 \text{ mA, } T_J = 100^{\circ}\text{C} \\ &V_{GS} = 5 \text{ V, } I_D = 50 \text{ mA} \\ &V_{GS} = 5 \text{ V, } I_D = 50 \text{ mA, } T_J = 100^{\circ}\text{C} \end{aligned}$	-	-	1.6 2.4 2 3	Ω
V _{DS(on)}	Drain-Source On-Voltage	$V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}$ $V_{GS} = 5 \text{ V}, I_D = 50 \text{ mA}$	-	-	3.75 1.5	V
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 2 V	500	-	-	mA
9 _{FS}	Forward Transconductance	V _{DS} = 2 V, I _D = 0.2 A	80	-	-	mS
YNAMIC CHA	ARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	_	-	50	pF
C _{oss}	Output Capacitance]	-	-	25	pF
C _{rss}	Reverse Transfer Capacitance]	-	-	5	pF
WITCHING C	HARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, R_L = 150 \Omega, V_{GS} = 10 \text{ V},$	-	-	20	ns
t _{d(off)}	Turn-Off Delay Time	I_D = 200 mA, R_{GEN} = 25 Ω	-	-	60	ns
RAIN-SOUR	CE DIODE CHARACTERISTICS					
IS	Maximum Continuous Drain-Source Diode Forward Current		-	-	115	mA
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	0.8	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 115 mA	_	_	1.1	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width < 300 µs, Duty Cycle < 2.0%.

TYPICAL PERFORMANCE CHARACTERISTICS

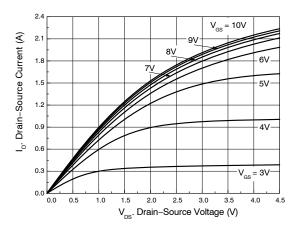


Figure 1. On-Region Characteristics

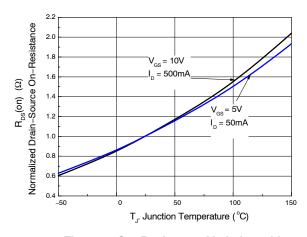


Figure 2. On–Resistance Variation with Temperature

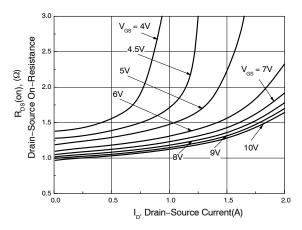


Figure 3. On–Resistance Variation with Gate Voltage and Drain Current

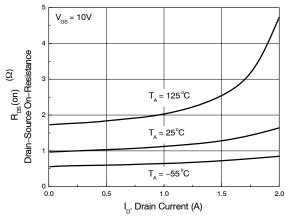


Figure 4. On–Resistance Variation with Drain Current and Temperature

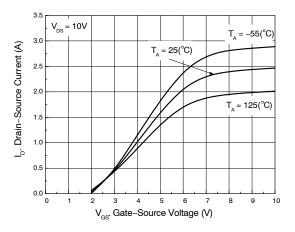


Figure 5. Transfer Characteristics

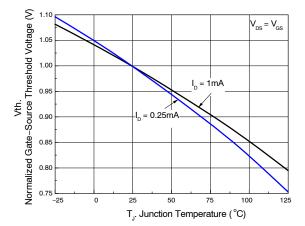


Figure 6. Gate Threshold Variation with Temperature

TYPICAL PERFORMANCE CHARACTERISTICS

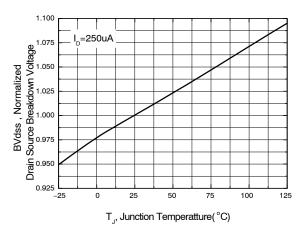


Figure 7. Breakdown Voltage Variation with Temperature

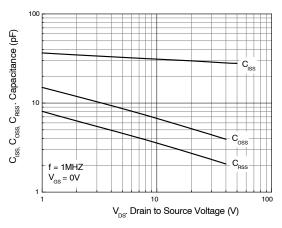


Figure 9. Capacitance Variation

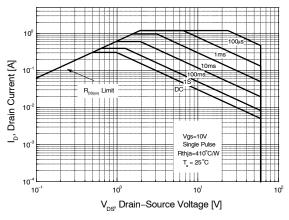


Figure 11. Maximum Safe Operating Area

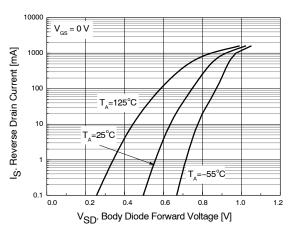


Figure 8. Body Diode Forward Voltage Variation with Source Current and Temperature

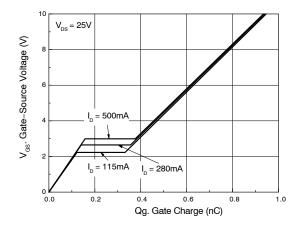


Figure 10. Gate Charge Characteristics

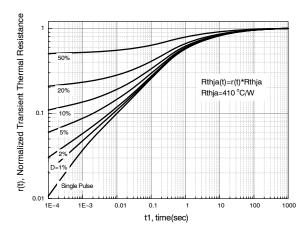
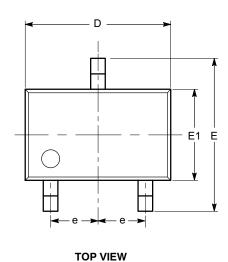


Figure 12. Transient Thermal Response Curve

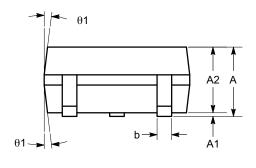


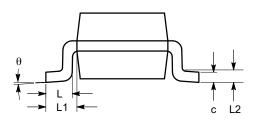
SC-70, 3 Lead, 1.25x2 CASE 419AB-01 ISSUE O

DATE 19 DEC 2008



SYMBOL	MIN	NOM	MAX
Α	0.80		1.10
A1	0.00		0.10
A2	0.80	0.90	1.00
b	0.15		0.30
С	0.08		0.22
D	1.80	2.00	2.20
E	1.80	2.10	2.40
E1	1.15	1.25	1.35
е		0.65 BSC	
L	0.26	0.36	0.46
L1		0.42 REF	
L2		0.15 BSC	
θ	0°		8°
θ1	4°		10°





SIDE VIEW

END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.(2) Complies with JEDEC MO-203.

DOCUMENT NUMBER:	98AON34256E	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SC-70, 3 LEAD, 1.25X2		PAGE 1 OF 1	

ON Semiconductor and III are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative